

Title (en)
Solder ball container

Title (de)
Behälter für Lötkugeln

Title (fr)
Récipient pour billes de soudure

Publication
EP 1155969 B1 20060215 (EN)

Application
EP 00401387 A 20000519

Priority
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Abstract (en)
[origin: EP1155969A1] A cylindrical container (1) with a bottom has an opening (4) in which a projection (8) is installed, the projection having a shape which will not deform solder balls (B) when inserted into a packet layer of solder balls within the container. Its shape is such that its cross section has a streamlined or inverted conical shape, or it is cylindrical with a tip having a semi-spherical or inverted conical shape. Blackening, electrical charging, and deformation of solder balls packed in the container can be prevented during transport. <IMAGE>

IPC 8 full level
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CPC (source: EP)
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